



MULTI-INNO TECHNOLOGY CO., LTD.

LCD MODULE SPECIFICATION

Model : MI24064K-G

Revision	
Engineering	
Date	
Our Reference	

**MODE OF DISPLAY****Display mode**

- STN : ☐ Yellow green
☐ Grey
☐ Blue (negative)
☐ FSTN positive
☐ FSTN negative

Display condition

- ☐ Reflective type
☐ Transflective type
☐ Transmissive type
☐ Others

Viewing direction

- ☐ 6 O' clock
☐ 12 O' clock
☐ 3 O' clock
☐ 9 O' clock

LCD MODULE NUMBER NOTATION:

**GENERAL DESCRIPTION**

Display mode : 240 X 64 dots, graphic COG LCD module
Interface : Serial
Driving method : 1/65 duty, 1/7 bias
Controller IC : SUNPLUS SPLC502A x 2
For the detailed information, please refer to the IC specifications.

MECHANICAL DIMENSIONS

Item	Dimension	Unit	Item	Dimension	Unit
Outline Dimension			Viewing Area	102.4(L)x30.22(W)	mm
Non Backlight (N)	108.0(L)x43.2(W)x 3.5 MAX(H)	mm	Dot Pitch	0.41(L)x0.41(W)	mm
LED Sided Backlight(L)	108.0(L)x43.2(W)x 7.0 MAX(H)	mm	Dot Size	0.38(L)x0.38(W)	mm

CONNECTOR PIN ASSIGNMENT

Pin No	Symbol	Function
1	/RES	Reset
2	/CSA	Master Chip select signal
3	/CSB	Slave Chip select signal
4	AO	Data control signal
5	SCLK	Serial input clock
6	SID	Serial input data
7	VDD	Supply voltage for logic
8	VSS	Ground
9	A	Supply voltage for backlight(+VE)
10	K	Supply voltage for backlight(-VE)

COUNTER DRAWING OF MODULE DIMENSION

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**ELECTRICAL CHARACTERISTICS**

Conditions: VSS=0V, Ta=25°C

Item	Symbol	MIN.	TYP.	MAX.	Unit	Item	Symbol	MIN.	TYP.	MAX.	Unit
Supply Voltage for Logic	VDD	2.75	3.0	3.25	V	“H”Level Input Voltage	VIH	0.8VDD	—	VDD	V
Supply Current for Logic	IDD	—	0.36	0.40	mA	“L”Level Input Voltage	VIL	VSS	—	0.2VDD	V
Power supply for LCD control (*)	VOUT	7.8	8.0	8.2	V	—	—	—	—	—	—
EL Backlight Voltage (VEL)											
EL (@ Frequency 400Hz)	VBL	—	—	—	Vrms	—	—	—	—	—	—
Side-lited LED Backlight Forward Voltage (VF)						Side-lited LED Backlight Forward Current (If)					
White	VBL	—	5.0	—	V	White	IBL	—	105	120	mA
Blue	VBL	—	—	—	V	Blue	IBL	—	—	—	mA
Yellow Green	VBL	—	—	—	V	Yellow Green	IBL	—	—	—	mA

ABSOLUTE MAXIMUM RATINGS

Please make sure not to exceed the following maximum rating values under the worst application conditions

Item	Symbol	Rating (for normal temperature)	Rating (for wide temperature)	Unit
Supply Voltage	VDD	3.0	3.0	V
Input Voltage	VT	-0.3 to VDD +0.3	-0.3 to VDD +0.3	V
Operating Temperature	Topr	0 to 50	-20 to 70	°C
Storage Temperature	Tstg	-10 to 60	-30 to 80	°C

COMMANDS TABLE

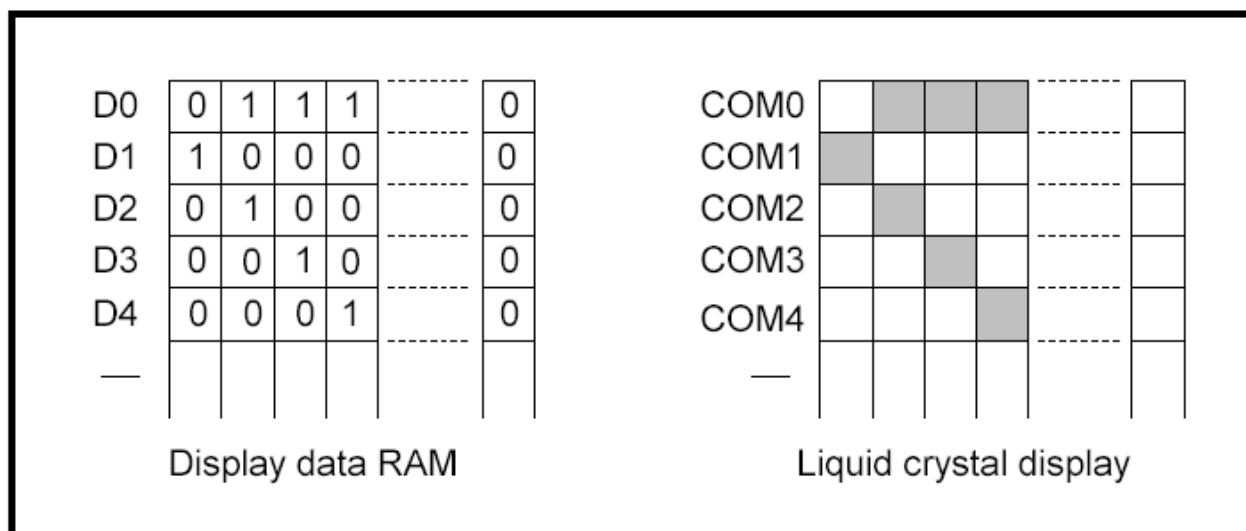
Command	Command Code											Function
	A0P	RD	WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	
1). Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0	LCD display ON/OFF 0: OFF, 1: ON
2). Display start line set	0	1	0	0	1	Display start address					Sets the display RAM display start line address	
3). Page address set	0	1	0	1	0	1	1	Page address				Sets the display RAM page address
4). Column address set upper bit	0	1	0	0	0	0	1	Most significant column address				Sets the most significant 4 bits of the display RAM column address.
Column address set lower bit	0	1	0	0	0	0	0	Least significant column address				Set the least significant 4 bits of the display RAM column address.
5). Status read	0	0	1	Status				0	0	0	0	Reads the status data
6). Display data write	1	1	0	Write data							Writes to the display RAM	
7). Display data read	1	0	1	Read data							Reads from the display RAM	
8). ADC select	0	1	0	1	0	1	0	0	0	0	0	Sets the display RAM address SEG output correspondence 0: normal, 1:reverse
9). Display normal/reverse	0	1	0	1	0	1	0	0	1	1	0	Sets the LCD display normal/ reverse 0: normal, 1:reverse
10). Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0	Display all points 0: normal display 1: all points ON
11). LCD bias set	0	1	0	1	0	1	0	0	0	1	0	Sets the LCD driver voltage bias ratio SPLC502A.....0:1/9, 1:1/7
12). Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0
13). End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write
14). Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset
15). Common output mode select	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction 0: normal direction, 1: reverse direction
16). Power control set	0	1	0	0	0	1	0	1	Operating mode			Select internal power supply operating mode
17). V0 voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Resistor ratio			Select internal resistor ratio (Rb/Ra) mode
18). Electronic volume mode set	0	1	0	1	0	0	0	0	0	0	1	Set the V0 output voltage electronic volume register
Electronic volume register set	0	1	0	*	*	Electronic volume value						

COMMANDS TABLE(CONT.)

Command	Command Code										Function	
	A0P	$\overline{\text{RD}}$	$\overline{\text{WR}}$	DB7	DB6	DB5	DB4	DB3	DB2	DB1		DB0
19). Static indicator ON/OFF Static indicator Register set				1	0	1	0	1	1	0	0	0: OFF, 1: ON 1 Set the flashing mode
20). Page Blink Page selection	0	1	0	1	1	0	1	0	1	0	1	P7 - 0: 1 - blinking page 0 - no blinking, normal display
21). Power saver												Display OFF and display all points ON compound command
22). NOP	0	1	0	1	1	1	0	0	0	1	1	Command for non-operation
23). Test	0	1	0	1	1	1	1	*	*	*	*	Command for IC test. Do not use this command

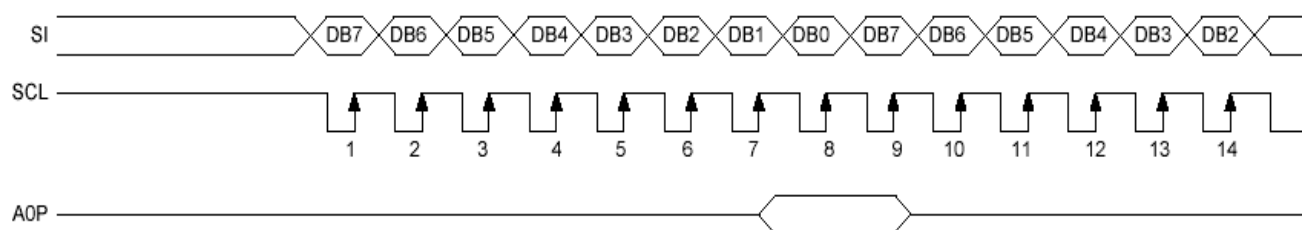
DISPLAY DATA RAM

The display data RAM is a RAM that stores the dot data for the display. It has a 65 (8 page x 8 bit +1) x 132-bit structure. It is possible to access the desired bit by specifying the page address and the column address. Because, as is shown in below, the DB7 - 0 display data from the MPU corresponds to the liquid crystal display common direction, there are few constraints at the time of display data transfer when multiple SPLC502A chips are used. Therefore, display structures can be created easily and with a high degree of freedom.

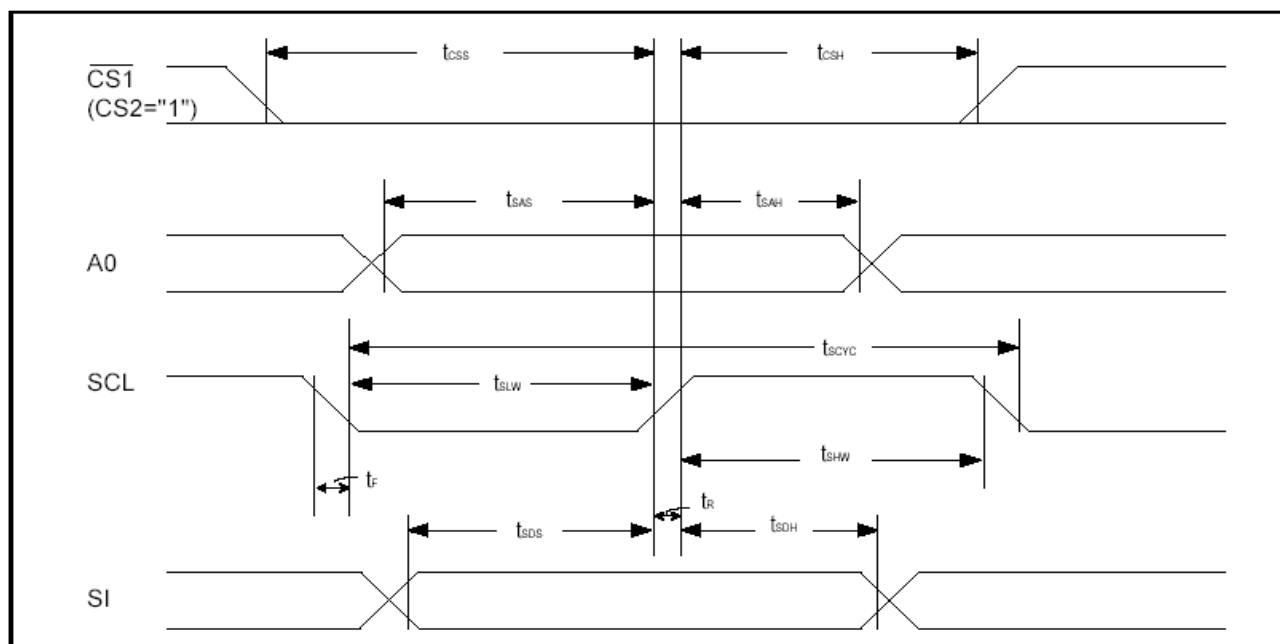


Regardless of the display start line address, the	
1/65 duty accesses	64 lines
1/55 duty accesses	54 lines
1/49 duty accesses	48 lines
1/33 duty accesses	32 lines

SERIAL INTERFACE SIGNAL CHART

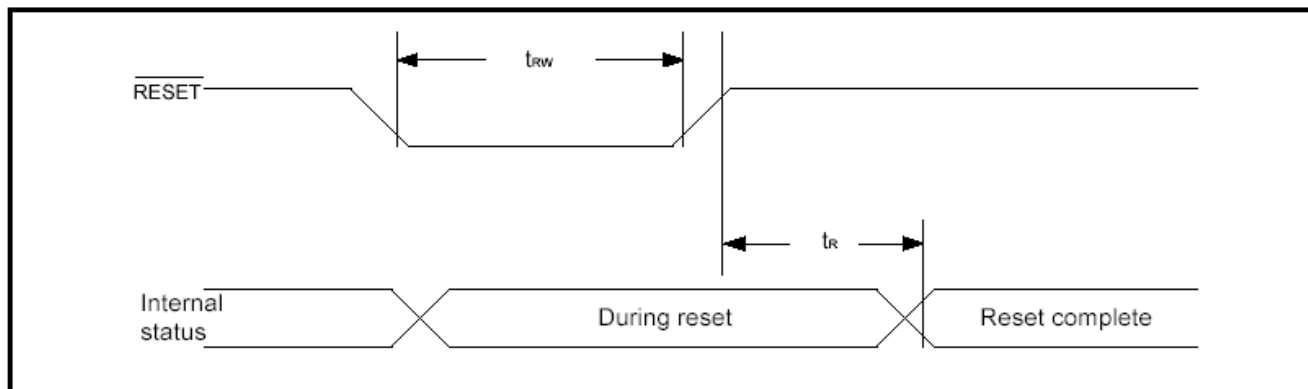


TIMING DIAGRAM AND CHARACTERISTICS



Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Serial Clock Period	SCL	t_{SCYC}	-	250	-	ns
SCL 'H' pulse width		t_{SHW}	-	100	-	ns
SCL 'L' pulse width		t_{SLW}	-	100	-	ns
Address setup time	A0P	t_{SAS}	-	150	-	ns
Address hold time		t_{SAH}	-	150	-	ns
Data setup time	SI	t_{SDS}	-	100	-	ns
Data hold time		t_{SDH}	-	100	-	ns
CS-SCL time	CS	t_{CSS}	-	150	-	ns
		t_{CSH}	-	150	-	ns

RESET TIMING



Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
Reset time		t_R	-	-	-	1.0	μs
Reset 'L' pulse width	RES	t_{RW}	-	1.0	-	-	μs

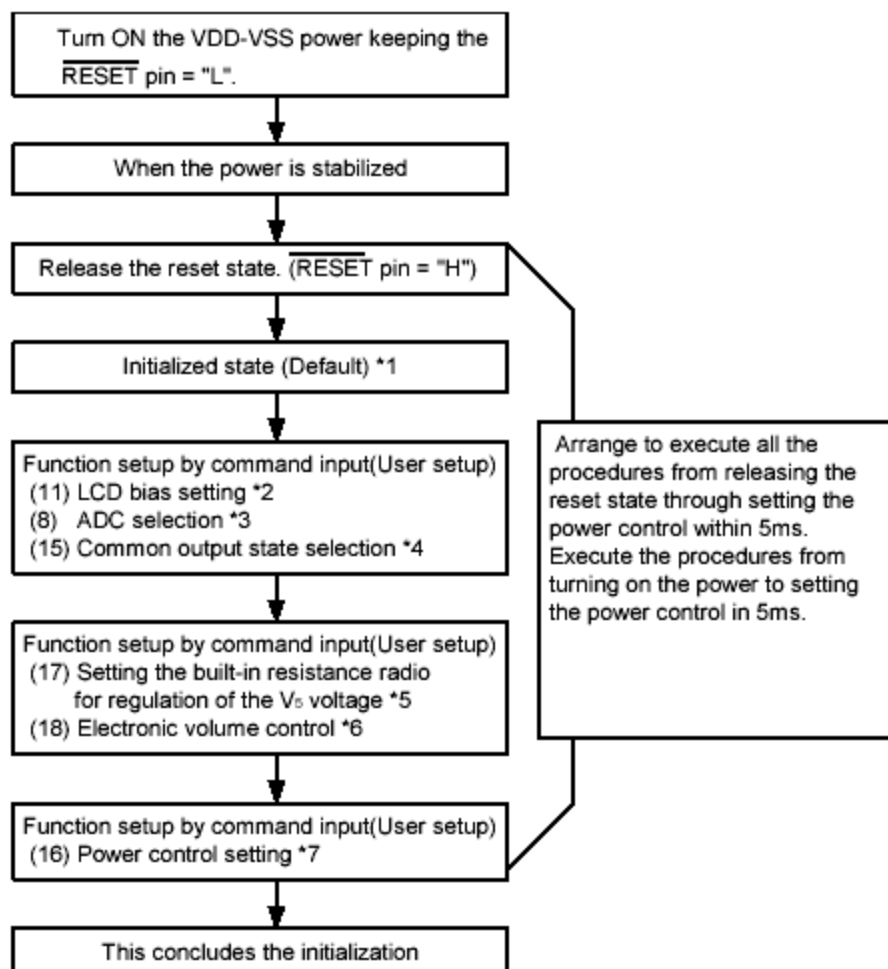
Note: All timing is specified with 20% and 80% of VDD as the standard.

THE RESET CIRCUIT

When the RESET input comes to the 'L' level, these LSIs return to the default state. Their default states are as follows:

- 1). Display OFF
- 2). Normal display
- 3). ADC select: Normal (ADC command DB0 = 'L')
- 4). Power control register: (DB2, DB1, DB0) = (0, 0, 0)
- 5). Serial interface internal register data clear
- 6). LCD power supply bias rate: SPLC502A.....1/9 bias
- 7). All-indicator lamps-on OFF (All-indicator lamps ON/OFF command DB0 = 'L')
- 8). Power saving clear
- 9). V0 voltage regulator internal resistors, Ra and Rb, are connected.
- 10). Output conditions of SEG and COM terminals SEG: VSS, COM: VSS
- 11). Read modify write OFF
- 12). Static indicator OFF Static indicator register: (DB1, DB2) = (0, 0)
- 13). Display start line set to first line
- 14). Column address set to Address 0
- 15). Page address set to Page 0
- 16). Common output status normal
- 17). V0 voltage regulator internal resistor ratio set mode clear
- 18). Electronic volume register set mode clear Electronic volume register: (DB5, DB4, DB3, DB2, DB1, DB0) = (1, 0, 0, 0, 0, 0)
- 19). Test mode clear

INITIALIZATION FLOWCHART(With built-in power supply circuit)



Note1: The target time of 5ms varied depending on the panel characteristics and the capacitance of the smoothing capacitor. Therefore, we suggest users to conduct an operation check using the actual equipment.

Note2: Refer to respective sections or paragraphs listed below.

- *1:Description of functions; Reset circuit
- *2:Command description; LCD bias setting
- *3:Command description; ADC selection
- *4:Command description; Common output state selection
- *5:Description of functions; Power circuit & Command description;
Setting the built-in resistance ratio for regulation of the V_s voltage
- *6:Description of functions; Power circuit & Command description;
Electronic volume control
- *7:Description of functions; Power circuit & Command description;
Power control setting.

**ELECTRO-OPTICAL CHARACTERISTICS**

MEASURING CONDITION: POWER SUPPLY = V_{OP} / 64 Hz
TEMPERATURE = 22 ± 5 °C
RELATIVE HUMIDITY = 60 ± 15 %

ITEM	SYMBOL	UNIT	TYP. TN	TYP. STN
RESPONSE TIME	Ton	ms	-	220
	Toff	ms	-	280
CONTRAST RATIO	Cr	-	-	12
VIEWING ANGLE (Cr ≥ 2)	V3:00	°	-	40
	V6:00	°	-	70
	V9:00	°	-	40
	V12:00	°	-	50

THE ELECTRO-OPTICAL CHARACTERISTICS ARE MEASURED VALUE BUT NOT GUARANTEED ONES.

RELIABILITY OF LCD MODULE

ITEM	TEST CONDITION FOR NORMAL TEMPERATURE	TEST CONDITION FOR WIDE TEMPERATURE	TIME
High temperature operating	50°C	70°C	240 hours
Low temperature operating	0°C	-20°C	240 hours
High temperature storage	60°C	80°C	240 hours
Low temperature storage	-10°C	-30°C	240 hours
Temperature-humidity storage	40°C 90% R.H.	60°C 90% R.H.	96 hours
Temperature cycling	-10°C to 60°C 30 Min Dwell	-30°C to 80°C 30 Min Dwell	5 cycle
Vibration Test at LCM Level	Freq 10-55 Hz Sweep rate: 10-55-10 at 1 min Sweep mode Linear Displacement: 2 mm p-p 1 Hour each for X, Y, Z	Freq 10-55 Hz Sweep rate: 10-55-10 at 1 min Sweep mode Linear Displacement: 2 mm p-p 1 Hour each for X, Y, Z	—

**QUALITY STANDARD OF LCD MODULE**

1.0	Sampling Method		
	Sampling Plan : MIL STD 105 E Class of AQL : Level II/Single Sampling Critical : 0.25% Major 0.65% Minor 1.5%		
2.0	Defect Group	Failure Category	Failure Reasons
	Critical Defect 0.25%(AQL)	Malfunction	Open Short Burnt or dead component Missing part/improper part P.C.B. Broken
	Major Defect 0.65%(AQL)	Poor Insulation	Potential short High current Component damage or scratched or Lying too close improper coating
		Poor Conduction	Damage joint Wrong polarity Wrong spec. part Uneven/intermittent contact Loose part Copper peeling Rust or corrosion or dirt's
	Minor Defect 1.5%(AQL)	Cosmetic Defect	Minor scratch Flux residue Thin solder Poor plating Poor marking Crack solder Poor bending Poor packing Wrong size

SAMPLING METHOD

SAMPLING PLAN: MIL-STD 105E

CLASS OF AQL: LEVEL II/ SINGLE SAMPLING
MAJOR-0.65% MINOR – 1.5%

QUALITY STANDARD

DEFECT	CRITERIA	TYPE	FIGURE
SHORT CIRCUIT	-	MAJOR	-
MISSING SEGMENT	-	MAJOR	-
UNEVEN / POOR CONTRAST	-	MAJOR	-
CROSS TALK	-	MAJOR	-
PIN HOLE	$\text{MAX}(a,b) \leq 1/4 W$	MINOR	1
EXCESS SEGMENT	$\text{MAX}(c,d) \leq 1/4 T$	MINOR	1
BUBBLES	$d^* \geq 0.2$ QTY=0	MINOR	2
BLACKS SPOTS	$d \leq 0.3$ N.A.** $0.3 < d \leq 0.4$ QTY ≤ 1 $0.4 < d$ QTY=0	MINOR	2
LINE SCRATCHES	$x \geq 0.7$ $y \geq 0.05$ QTY=0	MINOR	3
BLACK LINE	$x \geq 0.7$ $y \geq 0.05$ QTY=0	MINOR	3

*d = MAX (d₁,d₂)

** N. A . = NOT APPLICABLE

DEFECT TABLE : B

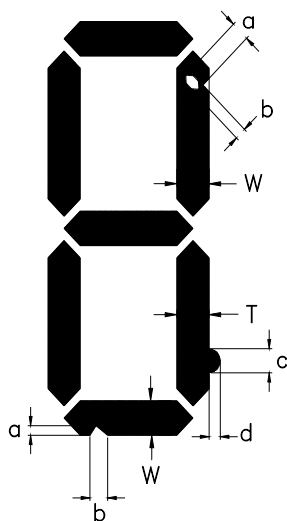
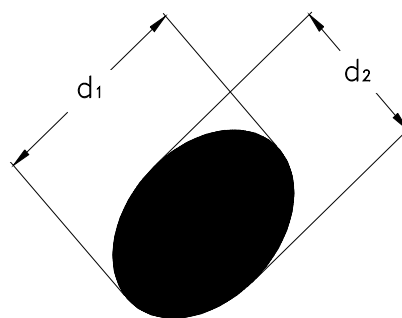
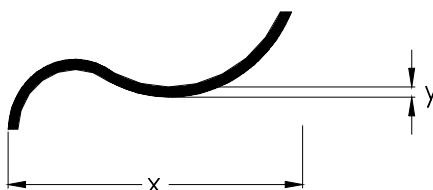


fig . 1



POLARIZER BUBBLES / SPOTS

fig . 2



LINE SCRATCHES / BLACK LINE

fig . 3

QUALITY STANDARD (CONT .)

DEFECT		CRITERIA	TYPE	FIGURE
CHIPS	CONTACT EDGE	$e \leq 1/2T$ $f \leq 1/3W$ $g \leq 3.5$	MINOR	4
	BOTTOM GLASS	$p \leq 1.0$ $q \leq 3.5$ $r \leq 1/2T$		4
	CORNER	$a \leq 1.5$ $b \leq W$		4
	TOP GLASS	$a \leq 3.0$ $b \leq 1/3T$ $c \leq 1/2W$		5
GLASS PROTRUSION		$a \leq 1/4 W$	MINOR	6
RAINBOW		-	MINOR	-

UNLESS STATE OTHERWISE , ALL UNIT ARE IN MILLIMETER .

DEFECT TABLE : B

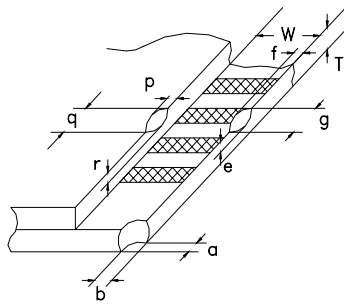


fig . 4

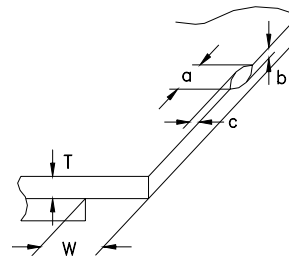


fig . 5

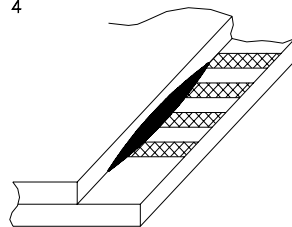
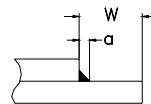


fig . 6





HANDLING PRECAUTIONS

(1) CAUTION OF LCD HANDLING & CLEANING

Use soft cloth with solvent (recommended below) to clean the display surface and wipe lightly.

- Isopropyl alcohol, ethyl alcohol, trichlorotrifluoroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent;

-water, ketone, aromatics

(2) CAUTION AGAINST STATIC CHARGE

The LCD modules use CMOS LSI drivers, so customers are recommended that any unused input terminal would be connected to V_{DD} or V_{SS} , do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

Remove the protective film slowly and, if possible, under ESD control device like ion blower and humidity of working room should be kept over 50%RH to reduce risk of static charge.

(3) PACKAGING

Avoid intense shock and falls from a height and do not operate or store them exposed direct to sunshine or high temperature/humidity.

(4) CAUTION FOR OPERATION

It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage than the limit causes the shorter LCD life. The use of direct current drive should be avoided because an electrochemical reaction due to direct current causes LCD's undesirable deterioration.

Response time will be extremely delayed at low temperature, and LCD's show dark color at high temperature. However those phenomena do not mean malfunction or out of order with LCD's.

Some font will be abnormally displayed when the display area is pushed hard during operation. But it resumes normal condition after turning off once.

(5) SAFETY

For crash damaged or unnecessary LCD's, it is recommended to wash off liquid crystal by either of solvents such as acetone and ethanol and should be burned up later.

When any liquid leaked out of a damaged glass cell comes in contact with your hands, wash it off with soap and water.

WARRANTY

Multi-Inno will replace or repair any of her LCD module in accordance with her LCD specification for a period of one year from date of shipment. The warranty liability of Multi-Inno is limited to repair and/or replacement. Multi-Inno will not be responsible for any subsequent or consequential event.